

EV Group Advances Leadership in Optical Lithography with Next-Generation EVG150 Resist Processing Platform – November 11, 2022





The Semiconductor Market Roller Coaster Ride is Back

Pat Gelsinger attended the WSJ Tech event in late October and as always had some interesting things to say about the state of the semiconductor industry. In the interview with the WSJ, Gelsinger laid out his view of the current industry environment and the long-term benefits of the CHIPS Act. From an industry perspective, Gelsinger stated that the semiconductor market has softened quickly. This is in part due to the demand that was created by COVID 19, and the industry response to meet that demand.

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IFTLE 539: IMAPS On-Shore Packaging & Assembly Workshop; TSMC 3DFabric Alliance

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Who is Your Global Partner for Semiconductor Plating Solutions?

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A Conversation with Beth Keser About Writing A Book on Advanced Fanout Wafer Level Packaging

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Member of the Week

SIEMENS

Exciting news this week for our community member, Siemens as they were selected by Bryan Black's new startup, Chipletz. Launched in 2021, Chipletz is a fabless substrate vendor developing advanced packaging technology to bridge the gap between the slowing of Moore's law and the rising demand of for computer performance. The company selected Siemens semiconductor packaging technologies to design its unique Smart Substrate based advanced packages.

"We selected Siemens as they demonstrated their technologies' capability and capacity, along with their expertise in advanced heterogeneous semiconductor package design." noted Black, Chipletz CEO. Siemens Digital Industries Software is a world leader in electronic hardware and software design solutions that help engineers conquer design challenges in the increasingly complex worlds of board and chip design.

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Community News

Chris Mann Joins Mosaic Microsystems as Vice President of Business Development

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ASE, EMD Electronics and KLA Corporation Representatives Appointed to SEMI Foundation Board of Trustees

Recommended Reads

Tektronix Partners with BRIDG to Boost Domestic Semiconductor Package Testing - Semiconductor Digest

EDA 2.0: Catalyzing the Human - EE Times

Events Calendar

SEMICON Europa 2022

Nov. 15-18, 2022

68th Annual IEEE International Electron Devices Meeting

12/03/2022 - 12/07/2022

SEMICON Japan

12/14/2022 - 12/16/2022

